

## N-Channel 8 V (D-S) MOSFET

### PRODUCT SUMMARY

| $V_{DS}$ (V) | $R_{DS(on)}$ ( $\Omega$ ) | $I_D$ (A) <sup>a</sup> | $Q_g$ (Typ.) |
|--------------|---------------------------|------------------------|--------------|
| 8            | 0.047 at $V_{GS} = 4.5$ V | 4.0 <sup>a</sup>       | 4.24 nC      |
|              | 0.051 at $V_{GS} = 2.5$ V | 4.0 <sup>a</sup>       |              |
|              | 0.058 at $V_{GS} = 1.8$ V | 4.0 <sup>a</sup>       |              |
|              | 0.069 at $V_{GS} = 1.5$ V | 4.0 <sup>a</sup>       |              |

### FEATURES

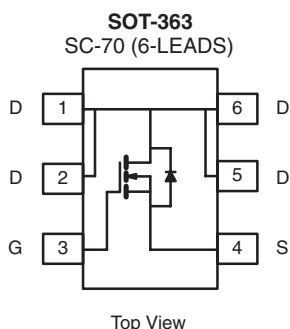
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET<sup>®</sup> Power MOSFET: 1.5 V Rated
- 100 %  $R_g$  Tested
- Compliant to RoHS Directive 2002/95/EC



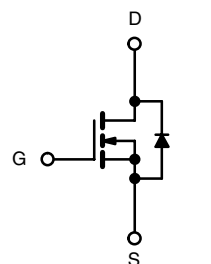
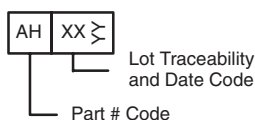
**RoHS**  
COMPLIANT  
**HALOGEN**  
**FREE**  
Available

### APPLICATIONS

- Load Switch for Portable Applications
  - Guaranteed Operation at  $V_{GS} = 1.5$  V
  - Critical for Optimized Design and Space Savings



#### Marking Code



N-Channel MOSFET

Ordering Information: Si1450DH-T1-E3 (Lead (Pb)-free)  
Si1450DH-T1-GE3 (Lead (Pb)-free and Halogen-free)

### ABSOLUTE MAXIMUM RATINGS $T_A = 25$ °C, unless otherwise noted

| Parameter                                                    | Symbol         | Limit                | Unit |
|--------------------------------------------------------------|----------------|----------------------|------|
| Drain-Source Voltage                                         | $V_{DS}$       | 8                    | V    |
| Gate-Source Voltage                                          | $V_{GS}$       | $\pm 5$              |      |
| Continuous Drain Current ( $T_J = 150$ °C)                   | $T_C = 25$ °C  | 6.04 <sup>a</sup>    | A    |
|                                                              | $T_C = 70$ °C  | 4.8 <sup>a</sup>     |      |
|                                                              | $T_A = 25$ °C  | 4.53 <sup>a</sup>    |      |
|                                                              | $T_A = 70$ °C  | 3.62 <sup>a</sup>    |      |
| Pulsed Drain Current                                         | $I_{DM}$       | 15                   | A    |
| Continuous Source-Drain Diode Current                        | $T_C = 25$ °C  | 2.3                  |      |
|                                                              | $T_A = 25$ °C  | 1.3 <sup>c</sup>     |      |
| Maximum Power Dissipation                                    | $T_C = 25$ °C  | 2.78                 | W    |
|                                                              | $T_C = 70$ °C  | 1.78                 |      |
|                                                              | $T_A = 25$ °C  | 1.56 <sup>b, c</sup> |      |
|                                                              | $T_A = 70$ °C  | 1.0 <sup>b, c</sup>  |      |
| Operating Junction and Storage Temperature Range             | $T_J, T_{stg}$ | - 55 to 150          | °C   |
| Soldering Recommendations (Peak Temperature) <sup>d, e</sup> |                | 260                  |      |

### THERMAL RESISTANCE RATINGS

| Parameter                                   | Symbol     | Typical | Maximum | Unit |
|---------------------------------------------|------------|---------|---------|------|
| Maximum Junction-to-Ambient <sup>b, f</sup> | $R_{thJA}$ | 60      | 80      | °C/W |
| Maximum Junction-to-Foot (Drain)            | $R_{thJF}$ | 34      | 45      |      |

Notes:

- Package limited.
- Surface mounted on 1" x 1" FR4 board.
- $t = 5$  s.
- Maximum under steady state conditions is 125 °C/W.

| SPECIFICATIONS T <sub>J</sub> = 25 °C, unless otherwise noted |                                      |                                                                                                                          |      |       |       |       |
|---------------------------------------------------------------|--------------------------------------|--------------------------------------------------------------------------------------------------------------------------|------|-------|-------|-------|
| Parameter                                                     | Symbol                               | Test Conditions                                                                                                          | Min. | Typ.  | Max.  | Unit  |
| Static                                                        |                                      |                                                                                                                          |      |       |       |       |
| Drain-Source Breakdown Voltage                                | V <sub>DS</sub>                      | V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA                                                                           | 8    |       |       | V     |
| V <sub>DS</sub> Temperature Coefficient                       | ΔV <sub>DS</sub> /T <sub>J</sub>     | I <sub>D</sub> = 250 μA                                                                                                  |      | 8.32  |       | mV/°C |
| V <sub>GS(th)</sub> Temperature Coefficient                   | ΔV <sub>GS(th)</sub> /T <sub>J</sub> |                                                                                                                          |      | - 2.7 |       |       |
| Gate-Source Threshold Voltage                                 | V <sub>GS(th)</sub>                  | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA                                                              | 0.3  |       | 1     | V     |
| Gate-Source Leakage                                           | I <sub>GSS</sub>                     | V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ± 5 V                                                                           |      |       | ± 100 | ns    |
| Zero Gate Voltage Drain Current                               | I <sub>DSS</sub>                     | V <sub>DS</sub> = 8 V, V <sub>GS</sub> = 0 V                                                                             |      |       | 1     | μA    |
|                                                               |                                      | V <sub>DS</sub> = 8 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C                                                     |      |       | 10    |       |
| On-State Drain Current <sup>a</sup>                           | I <sub>D(on)</sub>                   | V <sub>DS</sub> ≤ 5 V, V <sub>GS</sub> = 4.5 V                                                                           | 15   |       |       | A     |
| Drain-Source On-State Resistance <sup>a</sup>                 | R <sub>DS(on)</sub>                  | V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 4.0 A                                                                          |      | 0.039 | 0.047 | Ω     |
|                                                               |                                      | V <sub>GS</sub> = 2.5 V, I <sub>D</sub> = 4.0 A                                                                          |      | 0.042 | 0.051 |       |
|                                                               |                                      | V <sub>GS</sub> = 1.8 V, I <sub>D</sub> = 4.0 A                                                                          |      | 0.048 | 0.058 |       |
|                                                               |                                      | V <sub>GS</sub> = 1.5 V, I <sub>D</sub> = 1.28 A                                                                         |      | 0.053 | 0.069 |       |
| Forward Transconductance <sup>a</sup>                         | g <sub>fs</sub>                      | V <sub>DS</sub> = 4 V, I <sub>D</sub> = 4.0 A                                                                            |      | 15.5  |       | S     |
| Dynamic <sup>b</sup>                                          |                                      |                                                                                                                          |      |       |       |       |
| Input Capacitance                                             | C <sub>iss</sub>                     | V <sub>DS</sub> = 4 V, V <sub>GS</sub> = 0 V, f = 1 MHz                                                                  |      | 535   |       | pF    |
| Output Capacitance                                            | C <sub>oss</sub>                     |                                                                                                                          |      | 120   |       |       |
| Reverse Transfer Capacitance                                  | C <sub>rss</sub>                     |                                                                                                                          |      | 61    |       |       |
| Total Gate Charge                                             | Q <sub>g</sub>                       | V <sub>DS</sub> = 4 V, V <sub>GS</sub> = 5 V, I <sub>D</sub> = 4.0 A                                                     |      | 4.7   | 7.05  | nC    |
|                                                               |                                      | V <sub>DS</sub> = 4 V, V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 4.0 A                                                   |      | 4.24  | 6.4   |       |
| Gate-Source Charge                                            | Q <sub>gs</sub>                      |                                                                                                                          |      | 1.2   |       |       |
| Gate-Drain Charge                                             | Q <sub>gd</sub>                      |                                                                                                                          |      | 0.810 |       |       |
| Gate Resistance                                               | R <sub>g</sub>                       | f = 1 MHz                                                                                                                |      | 7.3   | 11    | Ω     |
| Turn-On Delay Time                                            | t <sub>d(on)</sub>                   | V <sub>DD</sub> = 4 V, R <sub>L</sub> = 1.11 Ω<br>I <sub>D</sub> ≅ 3.6 A, V <sub>GEN</sub> = 4.5 V, R <sub>g</sub> = 1 Ω |      | 8     | 12    | ns    |
| Rise Time                                                     | t <sub>r</sub>                       |                                                                                                                          |      | 73    | 110   |       |
| Turn-Off Delay Time                                           | t <sub>d(off)</sub>                  |                                                                                                                          |      | 18    | 27    |       |
| Fall Time                                                     | t <sub>f</sub>                       |                                                                                                                          |      | 5     | 7.5   |       |
| Drain-Source Body Diode Characteristics                       |                                      |                                                                                                                          |      |       |       |       |
| Continuous Source-Drain Diode Current                         | I <sub>S</sub>                       | T <sub>C</sub> = 25 °C                                                                                                   |      |       | 2.6   | A     |
| Pulse Diode Forward Current                                   | I <sub>SM</sub>                      |                                                                                                                          |      |       | 15    |       |
| Body Diode Voltage                                            | V <sub>SD</sub>                      | I <sub>S</sub> = 2.6 A, V <sub>GS</sub> = 0 V                                                                            |      | 0.8   | 1.2   | V     |
| Body Diode Reverse Recovery Time                              | t <sub>rr</sub>                      | I <sub>F</sub> = 2.6 A, di/dt = 100 A/μs, T <sub>J</sub> = 25 °C                                                         |      | 14.3  | 21.45 | ns    |
| Body Diode Reverse Recovery Charge                            | Q <sub>rr</sub>                      |                                                                                                                          |      | 3.6   | 5.4   | nC    |
| Reverse Recovery Fall Time                                    | t <sub>a</sub>                       |                                                                                                                          |      | 6.8   |       | ns    |
| Reverse Recovery Rise Time                                    | t <sub>b</sub>                       |                                                                                                                          |      | 7.5   |       |       |

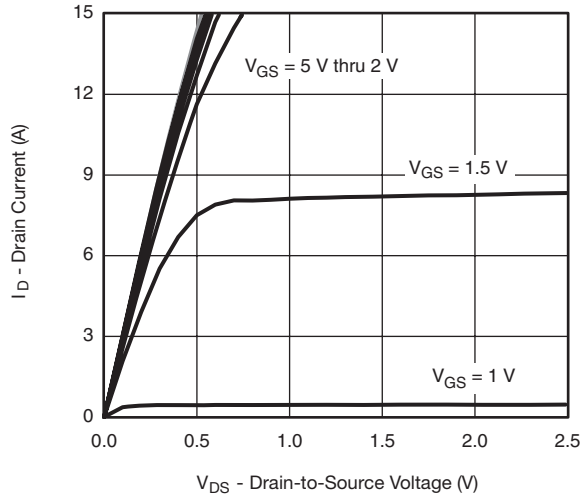
Notes:

a. Pulse test; pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$ .

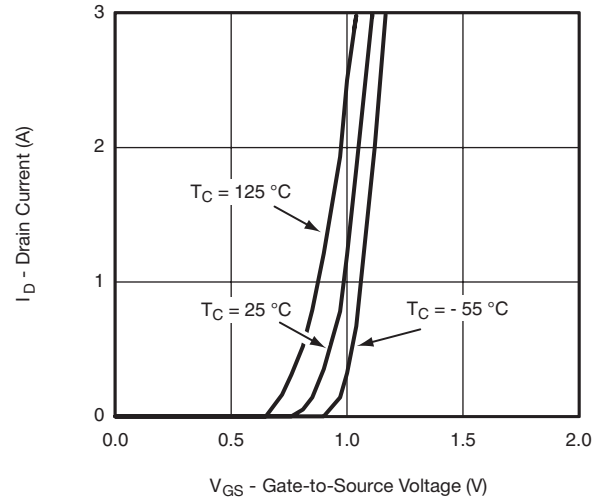
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

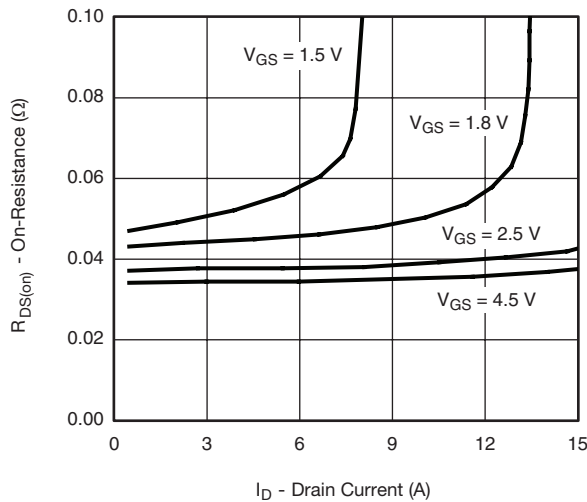
## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



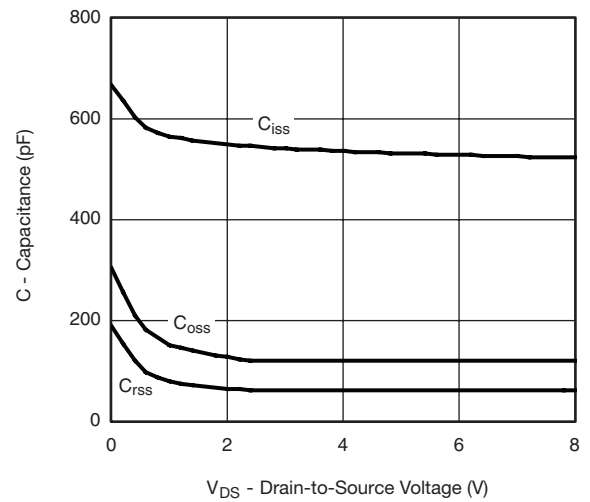
Output Characteristics



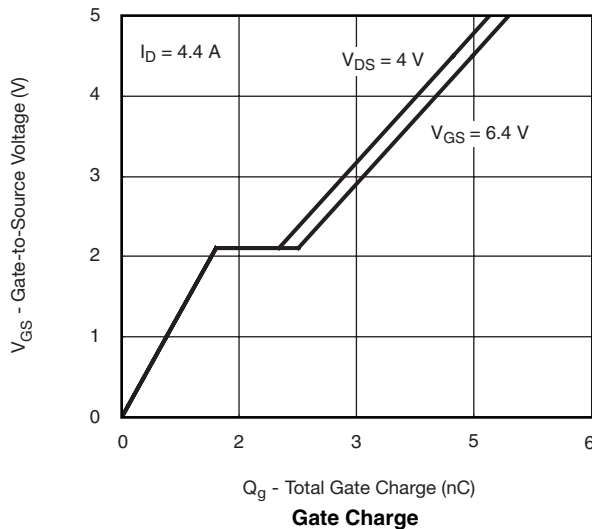
Transfer Characteristics



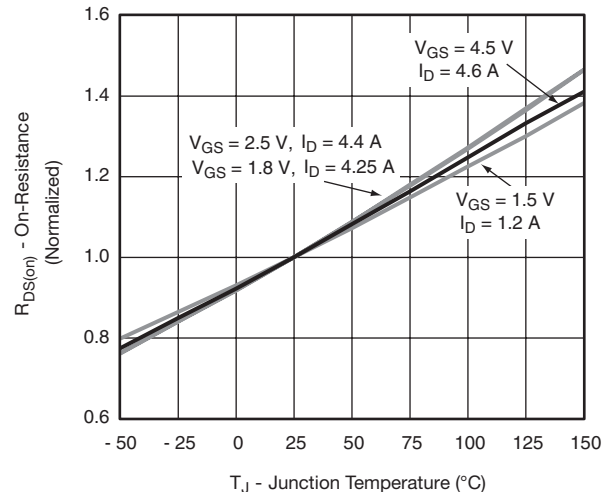
$R_{DS(on)}$  vs. Drain Current



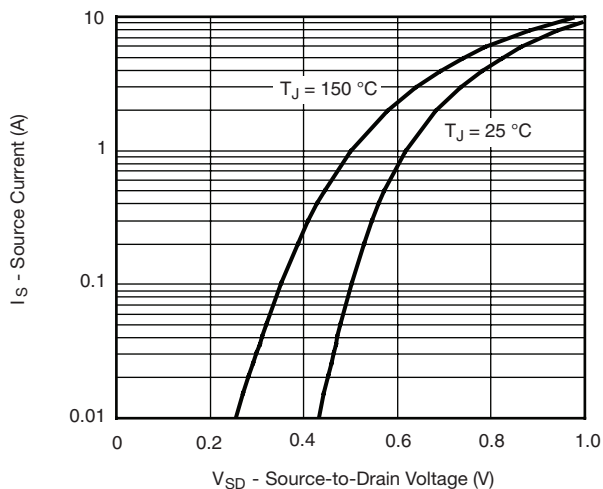
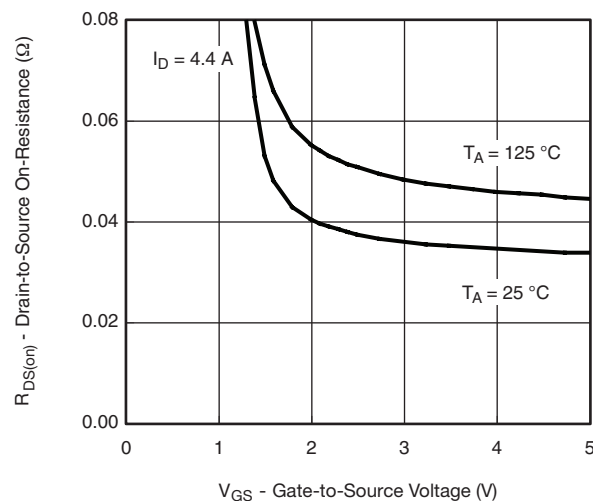
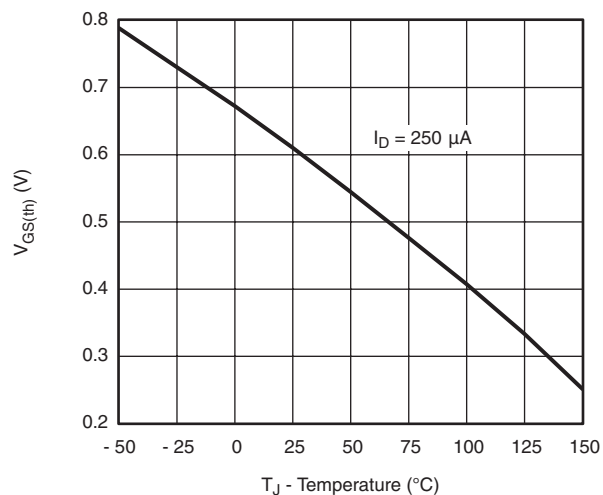
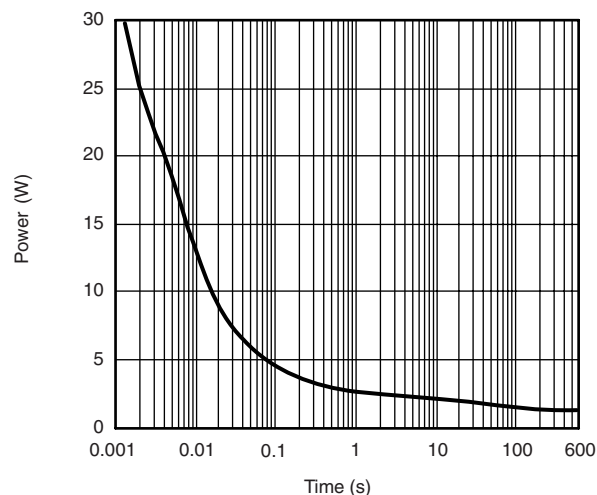
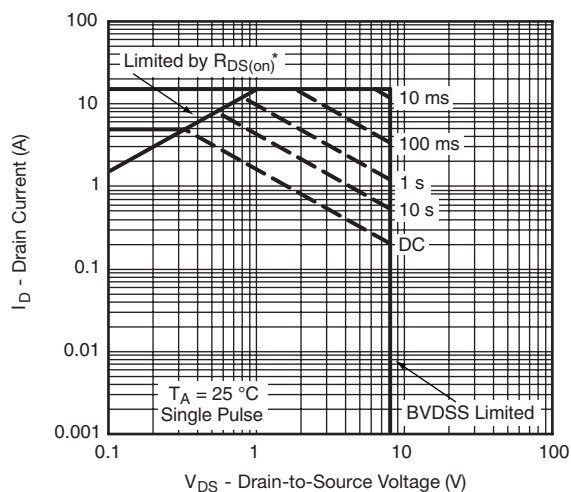
Capacitance



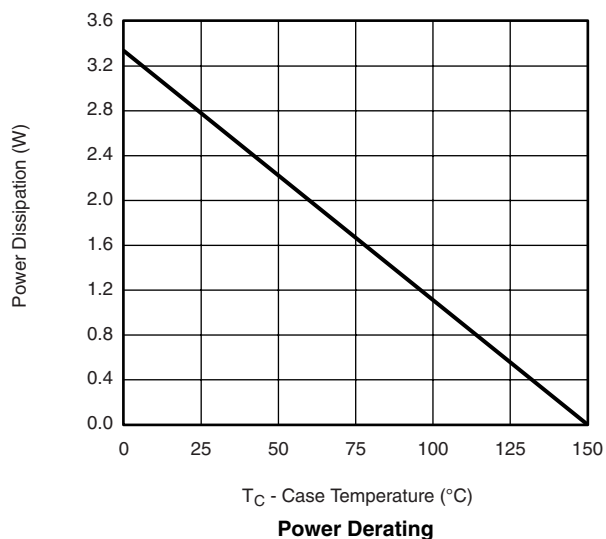
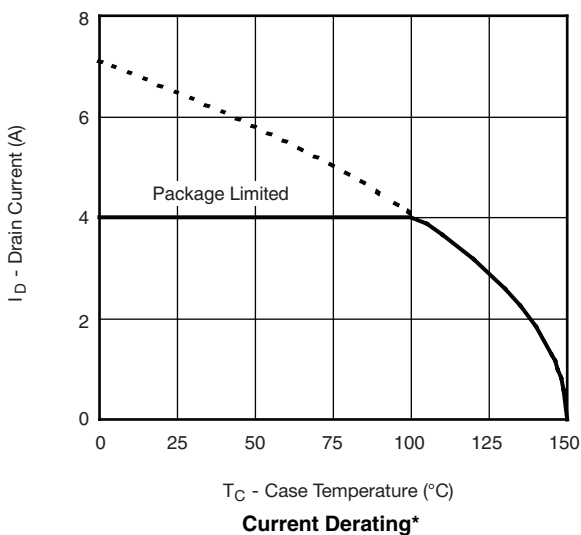
Gate Charge



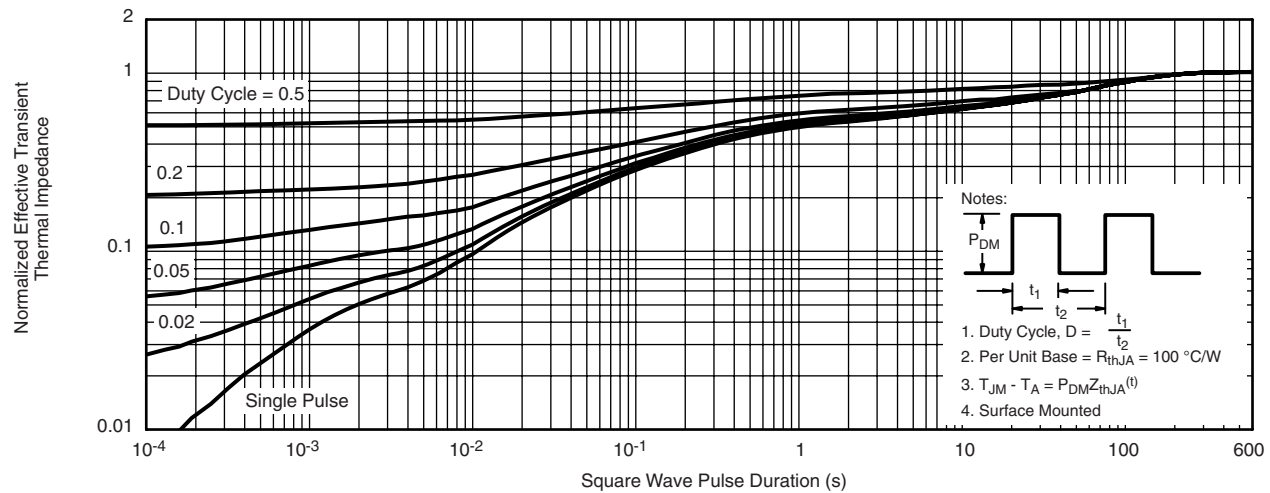
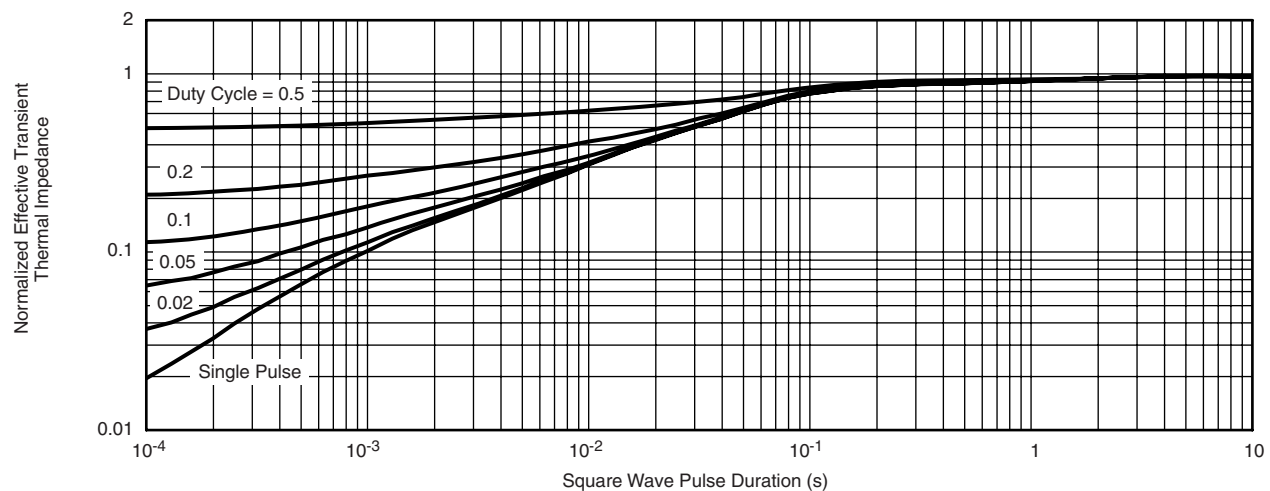
On-Resistance vs. Junction Temperature

**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted**Forward Diode Voltage vs. Temperature** **$R_{DS(on)}$  vs.  $V_{GS}$  vs. Temperature****Threshold Voltage****Single Pulse Power****Safe Operating Area, Junction-to-Case**

## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted**Normalized Thermal Transient Impedance, Junction-to-Ambient****Normalized Thermal Transient Impedance, Junction-to-Foot**

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